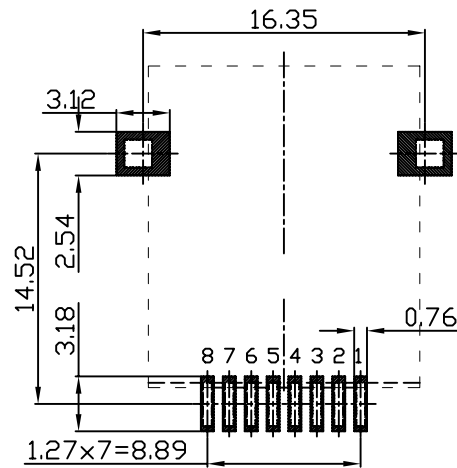
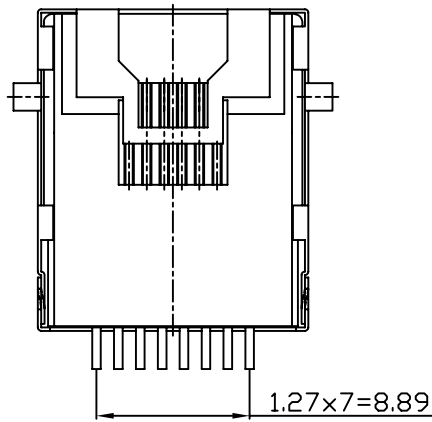
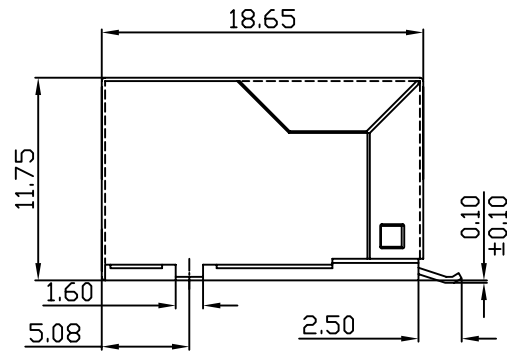
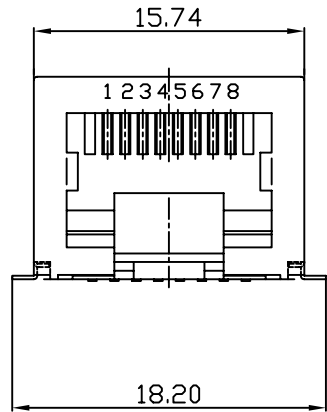


REV	ECN NO.	DATE
1	更新铜壳脚尺寸	2015.9.30



PAB LAYOUT

NOTES

- MATERIAL
- 1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC  
FLAMMABILITY RATING UL94V-0.
  - 2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
  - 3. PLATING : GOLD LATING OVER NICKEL IN CONTACT  
TIN PLATING OVER NICKEL IN SOLDER AREA.  
FU", 3U", 6U", 15U", 30U", 50U".
  - 4. SHIELD : 0.20mm THICKNESS COPPER ALLOY  
WITH NICKEL PLATED.

ELECTRICAL

- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
- 5. DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

- 1. DURRABILITY : 750 CYCLES MIN.
- 2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL :

- 1. STORAGE : -40°C~+85°C.
- 2. OPERATION : 0°C~+70°C.

RoHS Compliant

TOLERANCES 公差		DATE 日期	2013-06-14					
mm .0± 0.30 ±		MATERIAL 材质						
.00± 0.25 ±		FINISH 电镀			PART NO. 料号		SIZE A4	
.000± 0.10 ±		SCALE 比例	1:1	UNIT 单位	mm	Checked 审核		10
ANGLES ± 1°		Designed 设计		张旺新		Approved 核准		SHEET 1 OF 1
THIRD ANGLE PROJECTION								